

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4163329

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MICRON TECHNOLOGY, INC.	09/26/2008
RECEIVING PARTY DATA		
Name:	APTINA IMAGING CORPORATION	
Street Address:	C/O CITICO TRUSTEES (CAYMAN) LIMITED	
Internal Address:	REGATTA OFFICE PARK, WEST BAY ROAD	
City:	GRAND CAYMAN	
State/Country:	CAYMAN ISLANDS	
Postal Code:	Y1-1205	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Patent Number:	7960765
CORRESPONDENCE DATA		
Fax Number:	(602)244-3169	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	6022443574	
Email:	patents@onsemi.com	
Correspondent Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC	
Address Line 1:	5005 E. MCDOWELL ROAD	
Address Line 2:	MAILDROP A700	
Address Line 4:	PHOENIX, ARIZONA 85008	
ATTORNEY DOCKET NUMBER:	APT2004-1197D01	
NAME OF SUBMITTER:	SHARRON CASTILLO	
SIGNATURE:	/Sharron Castillo/	
DATE SIGNED:	11/30/2016	
Total Attachments: 7		
source=APT2004-1197D01_20161130_Assignment_MicronAptina#page1.tif		
source=APT2004-1197D01_20161130_Assignment_MicronAptina#page2.tif		
source=APT2004-1197D01_20161130_Assignment_MicronAptina#page3.tif		
source=APT2004-1197D01_20161130_Assignment_MicronAptina#page4.tif		

source=APT2004-1197D01_20161130_Assignment_MicronAptina#page5.tif

source=APT2004-1197D01_20161130_Assignment_MicronAptina#page6.tif

source=APT2004-1197D01_20161130_Assignment_MicronAptina#page7.tif

PATENT

REEL: 040468 FRAME: 0797

PATENT ASSIGNMENT AGREEMENT

1. Definitions

(a) "Agreement" shall mean this Patent Assignment Agreement.

(b) "Assignee" shall mean **Aptina Imaging Corporation**, a Cayman Islands corporation with offices at c/o Citco Trustees (Cayman) Limited, Regatta Office Park, West Bay Road, Grand Cayman, Y1-1205, Cayman Islands.

(c) "Assignor" shall mean **Micron Technology, Inc.**, a Delaware corporation with offices at 8000 South Federal Way, Boise, ID 83707.

(d) "Effective Date" shall mean October 3, 2008.

(e)



(f)



(g) "Imaging Patents" shall mean those patents identified in ATTACHMENT "A" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(h) "Imaging Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "B" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(i) "Semiconductor Patents" shall mean those patents identified in ATTACHMENT "D" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(j) "Semiconductor Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "E" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(k) [REDACTED]

2. [REDACTED]

(a) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Imaging Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Imaging Patents to Assignee and to record assignment of the Imaging Patents to Assignee.

(b) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Imaging Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Imaging Patent Applications to Assignee.

(c) [REDACTED]

(d) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, and subject further to the restrictions on the Semiconductor Patents set out below, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Semiconductor Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Semiconductor Patents to Assignee and to record assignment of the Semiconductor Patents to Assignee.

(e) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, [REDACTED], Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Semiconductor Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Semiconductor Patent Applications to Assignee.

(f)

[REDACTED]

[REDACTED]

[REDACTED]

3 [REDACTED]

[REDACTED]

4. [REDACTED]

[REDACTED]

5. [REDACTED]

[REDACTED]

[REDACTED]

6. [REDACTED]

[REDACTED]

7. General

This Agreement shall be effective as of the Effective Date hereof and shall be binding on the respective heirs, assigns, representatives, and successors of Assignor and of Assignee.

[the rest of this page intentionally left blank]

Agreed to by:

Micron Technology, Inc.

Signed: _____

Date: 9/26/08, 2008

Notarization

State of Idaho

County of Ada

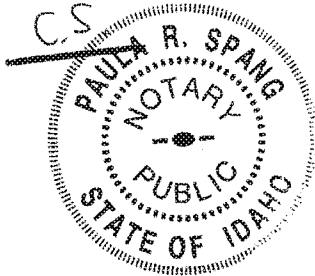
On 9/26/08, before me, Paula R. Spang, personally appeared the above-named Steven R. Appleton

who executed this Assignment in my presence and acknowledged to me that he did so of his own free will and in his authorized capacity for the purposes set forth herein.

Signed: _____

My commission expires: 8/12/11

REVIEWED
MTI LEGAL



Agreed to by:

Aptina Imaging Corporation

Signed: _____

Date: 9/26/08, 2008

Notarization

State of Idaho

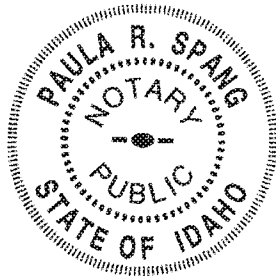
County of Ada

On 9/26/08, before me, Paula R. Spang, personally appeared the above-named Thomas L. Laws, Jr.

who executed this Assignment in my presence and acknowledged to me that he did so of his own free will and in his authorized capacity for the purposes set forth herein.

Signed: _____

My commission expires: 8/12/11



[Signature page to the Patent Assignment Agreement]

ATTACHMENT "B"



Aptina Applications

FILE NUMBER	TITLE	STATUS	COUNTRY NAME	APPLICATION NUMBER	DATE FILED
	GATES				
2004-1197.00/KR	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	Republic of Korea		Jan 5, 2007
2004-1197.00/PC	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Completed	PCT	PCTUS2007000407	Jan 5, 2007
2004-1197.00/SG	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	Singapore		Jan 5, 2007
2004-1197.00/TW	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	Taiwan R.O.C.	096100819	Jan 9, 2007
2004-1197.00/US	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	United States of America	11327377	Jan 9, 2006
2004-1229.01/US	METHOD AND APPARATUS PROVIDING GRADED-INDEX MICRO LENSES	Pending	United States of America	11501055	Aug 9, 2006
2004-1228.02/US	METHOD AND APPARATUS PROVIDING GRADED-INDEX MICRO LENSES	Pending	United States of America	11797317	May 2, 2007
2004-1250.00/US	METHOD AND APPARATUS PROVIDING INTEGRATED COLOR PIXEL WITH BURIED SUB-WAVELENGTH GRATINGS IN SOLID STATE IMAGERS	Pending	United States of America	11209774	Aug 24, 2005
2004-1299.00/US	STRUCTURE AND METHOD FOR BUILDING A PIXEL WAVEGUIDE ON IMAGING DEVICES	Pending	United States of America	11193450	Aug 1, 2005
2004-1355.00/CN	COLOR PIXELS WITH ANTI-BLOOMING ISOLATION	Pending	China	2006800168256	May 12, 2006